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## Product Change Notification - JAON-15OELO113

**Date:** 29 Jun 2016  
**Product Category:** Memory; Analog (Thermal, Power Management & Safety); Analog (Linear & Mixed Signal) AND Interface; 8-bit Microcontrollers  
**Notification subject:** CCB 2594 Final Notice: Qualification of CuPdAu bond wire in selected products of the 150K and 160K wafer technologies available in 8L MSOP package at MTAI assembly site.  
**Notification text:** **PCN Status:**  
Final notification

**Microchip Parts Affected:**

Please open the attachments found in the attachments field below labeled as PCN\_#\_Affected\_CPN.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

**Description of Change:**

Qualification of palladium coated copper with gold flash (CuPdAu) bond wire in selected products of the 150K and 160K wafer technologies available in 8L MSOP package at MTAI assembly site.

**Pre Change:**

Gold (Au) bond wire

**Post Change:**

Palladium coated copper with gold flash (CuPdAu) bond wire

**Pre and Post Change Summary:**

	Pre Change	Post Change
<b>Assembly Site</b>	MTAI assembly site	MTAI assembly site
<b>Wire material</b>	Au wire	CuPdAu wire
<b>Die attach material</b>	8390A	8390A
<b>Molding compound material</b>	G600	G600
<b>Lead frame material</b>	CDA194	CDA194

**Impacts to Data Sheet:**

None

**Reason for Change:**

To improve manufacturability and qualify Palladium coated copper with gold flash (CuPdAu) bond wire.

**Change Implementation Status:**

In Progress

**Estimated First Ship Date:**

July 24, 2016 (date code: 1629)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

**Time Table Summary:**

	June 2016					July 2016			
Workweek	22	23	24	25	26	27	28	29	30
Initial PCN Issue Date		X							
Qual Report Availability					X				
Final PCN Issue Date					X				
Estimated Implementation Date								X	

**Markings to Distinguish Revised from Unrevised Devices:**  
Traceability code

**Revision History:**

**June 8, 2016:** Issued initial notification.

**June 29, 2016:** Issued final notification. Attached the qualification report. Provided estimated first ship date. Updated the scope by removing selected products of the 250K wafer technology.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

**Attachment(s):**

- [PCN\\_JAON-15OELO113\\_Qual\\_Report.pdf](#)
- [PCN\\_JAON-15OELO113\\_Affected\\_CPN.pdf](#)
- [PCN\\_JAON-15OELO113\\_Affected\\_CPN.xls](#)

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JAON-15OELO113 - CCB 2594 Final Notice: Qualification of CuPdAu bond wire in selected products of the 150K and 160K wafer technologies available in 8L MSOP package at MTAI assembly site.

Affected Catalog Part Numbers (CPN)

PCN_JAON-15OELO113
CATALOG_PART_NBR
24AA01-I/MS
24AA01T-I/MS
24AA02-I/MS
24AA02T-I/MS
24AA044-E/MS
24AA044-I/MS
24AA044T-E/MS
24AA044T-I/MS
24AA04H-I/MS
24AA04HT-I/MS
24AA04-I/MS
24AA04T-I/MS
24AA08H-I/MS
24AA08HT-I/MS
24AA08-I/MS
24AA08T-I/MS
24AA128-I/MS
24AA128T-I/MS
24AA16-E/MS
24AA16H-I/MS
24AA16HT-I/MS
24AA16-I/MS
24AA16T-E/MS
24AA16T-I/MS
24AA256-E/MS
24AA256-I/MS
24AA256-I/MSRVE
24AA256T-E/MS
24AA256T-I/MS
24AA256T-I/MSRVE
24AA32AF-I/MS
24AA32AFT-I/MS
24AA32A-I/MS
24AA32AT-I/MS
24AA64-E/MS
24AA64F-I/MS
24AA64FT-I/MS
24AA64-I/MS
24AA64T-E/MS
24AA64T-I/MS
24FC128-I/MS
24FC128T-I/MS
24FC256-I/MS

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Affected Catalog Part Numbers (CPN)

PCN_JAON-15OELO113
CATALOG_PART_NBR
24FC256T-I/MS
24FC64F-I/MS
24FC64FT-I/MS
24FC64-I/MS
24FC64T-I/MS
24LC01B-I/MS
24LC01BT-I/MS
24LC02B-E/MS
24LC02B-I/MS
24LC02BT-E/MS
24LC02BT-I/MS
24LC04B-E/MS
24LC04BH-E/MS
24LC04BH-I/MS
24LC04BHT-E/MS
24LC04BHT-I/MS
24LC04B-I/MS
24LC04BT-E/MS
24LC04BT-I/MS
24LC08B-E/MS
24LC08BH-E/MS
24LC08BH-I/MS
24LC08BHT-E/MS
24LC08BHT-I/MS
24LC08B-I/MS
24LC08BT-E/MS
24LC08BT-I/MS
24LC128-E/MS
24LC128-I/MS
24LC128T-E/MS
24LC128T-I/MS
24LC16B-E/MS
24LC16BH-E/MS
24LC16BH-I/MS
24LC16BHT-E/MS
24LC16BHT-I/MS
24LC16B-I/MS
24LC16BT-E/MS
24LC16BT-I/MS
24LC256-E/MS
24LC256-I/MS
24LC256-I/MSRVF
24LC256T-E/MS

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Affected Catalog Part Numbers (CPN)

PCN_JAON-15OELO113
CATALOG_PART_NBR
24LC256T-I/MS
24LC256T-I/MSRVF
24LC32A-E/MS
24LC32AF-E/MS
24LC32AF-I/MS
24LC32AFT-E/MS
24LC32AFT-I/MS
24LC32A-I/MS
24LC32AT-E/MS
24LC32AT-I/MS
24LC64-E/MS
24LC64F-E/MS
24LC64F-I/MS
24LC64FT-E/MS
24LC64FT-I/MS
24LC64-I/MS
24LC64T-E/MS
24LC64T-I/MS
25AA010A-I/MS
25AA010AT-I/MS
25AA020A-I/MS
25AA020AT-I/MS
25AA040A-I/MS
25AA040AT-I/MS
25AA080A-I/MS
25AA080AT-I/MS
25AA080B-I/MS
25AA080BT-I/MS
25AA080C-I/MS
25AA080CT-I/MS
25AA080D-I/MS
25AA080DT-I/MS
25AA160A-I/MS
25AA160AT-I/MS
25AA160B-I/MS
25AA160BT-I/MS
25AA160C-I/MS
25AA160CT-I/MS
25AA160D-E/MS
25AA160D-I/MS
25AA160DT-E/MS
25AA160DT-I/MS
25AA320A-I/MS

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Affected Catalog Part Numbers (CPN)

PCN_JAON-15OELO113
CATALOG_PART_NBR
25AA320AT-I/MS
25AA640A-E/MS
25AA640A-I/MS
25AA640AT-E/MS
25AA640AT-I/MS
25LC010A-E/MS
25LC010A-I/MS
25LC010AT-E/MS
25LC010AT-I/MS
25LC020A-E/MS
25LC020A-I/MS
25LC020AT-E/MS
25LC020AT-I/MS
25LC040A-E/MS
25LC040A-I/MS
25LC040AT-E/MS
25LC040AT-I/MS
25LC080A-E/MS
25LC080A-I/MS
25LC080AT-E/MS
25LC080AT-I/MS
25LC080B-E/MS
25LC080B-I/MS
25LC080BT-E/MS
25LC080BT-I/MS
25LC080C-E/MS
25LC080C-I/MS
25LC080CT-E/MS
25LC080CT-I/MS
25LC080D-E/MS
25LC080D-I/MS
25LC080DT-E/MS
25LC080DT-I/MS
25LC160A-E/MS
25LC160A-I/MS
25LC160AT-E/MS
25LC160AT-I/MS
25LC160B-E/MS
25LC160B-I/MS
25LC160BT-E/MS
25LC160BT-I/MS
25LC160C-E/MS
25LC160C-I/MS

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Affected Catalog Part Numbers (CPN)

PCN_JAON-15OELO113
CATALOG_PART_NBR
25LC160CT-E/MS
25LC160CT-I/MS
25LC160D-E/MS
25LC160D-I/MS
25LC160DT-E/MS
25LC160DT-I/MS
25LC320A-E/MS
25LC320A-I/MS
25LC320AT-E/MS
25LC320AT-I/MS
25LC640A-E/MS
25LC640A-I/MS
25LC640AT-E/MS
25LC640AT-I/MS
93AA46A-I/MS
93AA46AT-I/MS
93AA46B-I/MS
93AA46BT-I/MS
93AA46C-I/MS
93AA46CT-I/MS
93AA56A-I/MS
93AA56AT-I/MS
93AA56B-I/MS
93AA56BT-I/MS
93AA56C-I/MS
93AA56CT-I/MS
93AA66A-I/MS
93AA66AT-I/MS
93AA66B-I/MS
93AA66B-I/MSL21
93AA66BT-I/MS
93AA66BT-I/MSL21
93AA66C-I/MS
93AA66CT-I/MS
93AA76A-I/MS
93AA76AT-I/MS
93AA76B-I/MS
93AA76BT-I/MS
93AA76C-I/MS
93AA76CT-I/MS
93AA86A-I/MS
93AA86AT-I/MS
93AA86B-I/MS

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Affected Catalog Part Numbers (CPN)

PCN_JAON-15OELO113
CATALOG_PART_NBR
93AA86BT-I/MS
93AA86C-I/MS
93AA86CT-I/MS
93C46A-E/MS
93C46A-I/MS
93C46AT-E/MS
93C46AT-I/MS
93C46B-E/MS
93C46B-I/MS
93C46BT-E/MS
93C46BT-I/MS
93C46C-E/MS
93C46C-I/MS
93C46CT-E/MS
93C46CT-I/MS
93C56A-E/MS
93C56A-I/MS
93C56AT-E/MS
93C56AT-I/MS
93C56B-E/MS
93C56B-I/MS
93C56BT-E/MS
93C56BT-I/MS
93C56C-E/MS
93C56C-I/MS
93C56CT-E/MS
93C56CT-I/MS
93C66A-E/MS
93C66A-I/MS
93C66AT-E/MS
93C66AT-I/MS
93C66B-E/MS
93C66B-I/MS
93C66BT-E/MS
93C66BT-I/MS
93C66C-E/MS
93C66C-I/MS
93C66CT-E/MS
93C66CT-I/MS
93C76A-E/MS
93C76A-I/MS
93C76AT-E/MS
93C76AT-I/MS



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Affected Catalog Part Numbers (CPN)

PCN_JAON-15OELO113
CATALOG_PART_NBR
93C76B-E/MS
93C76B-I/MS
93C76BT-E/MS
93C76BT-I/MS
93C76C-E/MS
93C76C-I/MS
93C76CT-E/MS
93C76CT-I/MS
93C86A-E/MS
93C86A-I/MS
93C86AT-E/MS
93C86AT-I/MS
93C86B-E/MS
93C86B-I/MS
93C86BT-E/MS
93C86BT-I/MS
93C86C-E/MS
93C86C-I/MS
93C86CT-E/MS
93C86CT-I/MS
93LC46A-E/MS
93LC46A-I/MS
93LC46AT-E/MS
93LC46AT-I/MS
93LC46B-E/MS
93LC46B-I/MS
93LC46BT-E/MS
93LC46BT-I/MS
93LC46C-E/MS
93LC46C-I/MS
93LC46CT-E/MS
93LC46CT-I/MS
93LC56A-E/MS
93LC56A-I/MS
93LC56AT-E/MS
93LC56AT-I/MS
93LC56B-E/MS
93LC56B-I/MS
93LC56BT-E/MS
93LC56BT-I/MS
93LC56C-E/MS
93LC56C-I/MS
93LC56CT-E/MS

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Affected Catalog Part Numbers (CPN)

PCN_JAON-15OELO113
CATALOG_PART_NBR
93LC56CT-I/MS
93LC66A-E/MS
93LC66A-I/MS
93LC66AT-E/MS
93LC66AT-I/MS
93LC66B-E/MS
93LC66B-I/MS
93LC66BT-E/MS
93LC66BT-I/MS
93LC66C-E/MS
93LC66C-I/MS
93LC66CT-E/MS
93LC66CT-I/MS
93LC76A-E/MS
93LC76A-I/MS
93LC76AT-E/MS
93LC76AT-I/MS
93LC76B-E/MS
93LC76B-I/MS
93LC76BT-E/MS
93LC76BT-I/MS
93LC76C-E/MS
93LC76C-I/MS
93LC76CT-E/MS
93LC76CT-I/MS
93LC86A-E/MS
93LC86A-I/MS
93LC86AT-E/MS
93LC86AT-I/MS
93LC86B-E/MS
93LC86B-I/MS
93LC86BT-E/MS
93LC86BT-I/MS
93LC86C-E/MS
93LC86C-I/MS
93LC86CT-E/MS
93LC86CT-I/MS
MCP1632-AAE/MS
MCP1632-BAE/MS
MCP1632T-AAE/MS
MCP1632T-BAE/MS
MCP3422A0-E/MS
MCP3422A0T-E/MS

JAON-15OELO113 - CCB 2594 Final Notice: Qualification of CuPdAu bond wire in selected products of the 150K and 160K wafer technologies available in 8L MSOP package at MTA1 assembly site.

Affected Catalog Part Numbers (CPN)

PCN_JAON-15OELO113
CATALOG_PART_NBR
MCP3422A1-E/MS
MCP3422A1T-E/MS
MCP3422A2-E/MS
MCP3422A2T-E/MS
MCP3422A3-E/MS
MCP3422A3T-E/MS
MCP3422A4-E/MS
MCP3422A4T-E/MS
MCP3422A5-E/MS
MCP3422A5T-E/MS
MCP3422A6-E/MS
MCP3422A6T-E/MS
MCP3422A7-E/MS
MCP3422A7T-E/MS
MCP3426A0-E/MS
MCP3426A0T-E/MS
MCP3426A1-E/MS
MCP3426A1T-E/MS
MCP3426A2-E/MS
MCP3426A2T-E/MS
MCP3426A3-E/MS
MCP3426A3T-E/MS
MCP3426A4-E/MS
MCP3426A4T-E/MS
MCP3426A5-E/MS
MCP3426A5T-E/MS
MCP3426A6-E/MS
MCP3426A6T-E/MS
MCP3426A7-E/MS
MCP3426A7T-E/MS
MCP3550-50E/MS
MCP3550-60E/MS
MCP3550T-50E/MS
MCP3550T-60E/MS
MCP3551-E/MS
MCP3551T-E/MS
MCP3553-E/MS
MCP3553T-E/MS
MCP4011-103E/MS
MCP4011-202E/MS
MCP4011-502E/MS
MCP4011-503E/MS
MCP4011T-103E/MS

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Affected Catalog Part Numbers (CPN)

PCN_JAON-15OELO113
CATALOG_PART_NBR
MCP4011T-202E/MS
MCP4011T-502E/MS
MCP4011T-503E/MS
MCP4021-103E/MS
MCP4021-202E/MS
MCP4021-502E/MS
MCP4021-503E/MS
MCP4021T-103E/MS
MCP4021T-202E/MS
MCP4021T-502E/MS
MCP4021T-503E/MS
MCP4131-103E/MS
MCP4131-104E/MS
MCP4131-502E/MS
MCP4131-503E/MS
MCP4131T-103E/MS
MCP4131T-104E/MS
MCP4131T-502E/MS
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MCP4132-503E/MS
MCP4132T-103E/MS
MCP4132T-104E/MS
MCP4132T-502E/MS
MCP4132T-503E/MS
MCP4141-103E/MS
MCP4141-104E/MS
MCP4141-502E/MS
MCP4141-503E/MS
MCP4141T-103E/MS
MCP4141T-104E/MS
MCP4141T-502E/MS
MCP4141T-503E/MS
MCP4142-103E/MS
MCP4142-104E/MS
MCP4142-502E/MS
MCP4142-503E/MS
MCP4142T-103E/MS
MCP4142T-104E/MS
MCP4142T-502E/MS
MCP4142T-503E/MS

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Affected Catalog Part Numbers (CPN)

PCN_JAON-15OELO113
CATALOG_PART_NBR
MCP4151-103E/MS
MCP4151-104E/MS
MCP4151-502E/MS
MCP4151-503E/MS
MCP4151T-103E/MS
MCP4151T-104E/MS
MCP4151T-502E/MS
MCP4151T-503E/MS
MCP4152-103E/MS
MCP4152-104E/MS
MCP4152-502E/MS
MCP4152-503E/MS
MCP4152T-103E/MS
MCP4152T-104E/MS
MCP4152T-502E/MS
MCP4152T-503E/MS
MCP4161-103E/MS
MCP4161-104E/MS
MCP4161-502E/MS
MCP4161-503E/MS
MCP4161T-103E/MS
MCP4161T-104E/MS
MCP4161T-502E/MS
MCP4161T-503E/MS
MCP4162-103E/MS
MCP4162-104E/MS
MCP4162-502E/MS
MCP4162-503E/MS
MCP4162T-103E/MS
MCP4162T-104E/MS
MCP4162T-502E/MS
MCP4162T-503E/MS
MCP4531-103E/MS
MCP4531-104E/MS
MCP4531-502E/MS
MCP4531-503E/MS
MCP4531T-103E/MS
MCP4531T-104E/MS
MCP4531T-502E/MS
MCP4531T-503E/MS
MCP4532-103E/MS
MCP4532-104E/MS
MCP4532-502E/MS

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Affected Catalog Part Numbers (CPN)

PCN_JAON-15OELO113
CATALOG_PART_NBR
MCP4532-503E/MS
MCP4532T-103E/MS
MCP4532T-104E/MS
MCP4532T-502E/MS
MCP4532T-503E/MS
MCP4541-103E/MS
MCP4541-104E/MS
MCP4541-502E/MS
MCP4541-503E/MS
MCP4541T-103E/MS
MCP4541T-104E/MS
MCP4541T-502E/MS
MCP4541T-503E/MS
MCP4542-103E/MS
MCP4542-104E/MS
MCP4542-502E/MS
MCP4542-503E/MS
MCP4542T-103E/MS
MCP4542T-104E/MS
MCP4542T-502E/MS
MCP4542T-503E/MS
MCP4551-103E/MS
MCP4551-104E/MS
MCP4551-502E/MS
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MCP4552-503E/MS
MCP4552T-103E/MS
MCP4552T-104E/MS
MCP4552T-502E/MS
MCP4552T-503E/MS
MCP4561-103E/MS
MCP4561-104E/MS
MCP4561-502E/MS
MCP4561-503E/MS
MCP4561T-103E/MS
MCP4561T-104E/MS

JAON-15OELO113 - CCB 2594 Final Notice: Qualification of CuPdAu bond wire in selected products of the 150K and 160K wafer technologies available in 8L MSOP package at MTA1 assembly site.

Affected Catalog Part Numbers (CPN)

PCN_JAON-15OELO113
CATALOG_PART_NBR
MCP4561T-502E/MS
MCP4561T-503E/MS
MCP4562-103E/MS
MCP4562-104E/MS
MCP4562-502E/MS
MCP4562-503E/MS
MCP4562T-103E/MS
MCP4562T-104E/MS
MCP4562T-502E/MS
MCP4562T-503E/MS
MCP4801-E/MS
MCP4801T-E/MS
MCP4802-E/MS
MCP4802T-E/MS
MCP4811-E/MS
MCP4811T-E/MS
MCP4812-E/MS
MCP4812T-E/MS
MCP4821-E/MS
MCP4821T-E/MS
MCP4822-E/MS
MCP4822T-E/MS
MCP4901-E/MS
MCP4901T-E/MS
MCP4911-E/MS
MCP4911T-E/MS
MCP4921-E/MS
MCP4921T-E/MS
MCP6422-E/MS
MCP6422T-E/MS
MCP6472-E/MS
MCP6472T-E/MS
MCP6482-E/MS
MCP6482T-E/MS
MCP6492-E/MS
MCP6492T-E/MS
MCP6N16-001E/MS
MCP6N16-010E/MS
MCP6N16-100E/MS
MCP6N16T-001E/MS
MCP6N16T-010E/MS
MCP6N16T-100E/MS
MCP6V12-E/MS

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Affected Catalog Part Numbers (CPN)

PCN_JAON-15OELO113
CATALOG_PART_NBR
MCP6V12T-E/MS
MCP6V32-E/MS
MCP6V32T-E/MS
MCP6V62-E/MS
MCP6V62T-E/MS
MCP6V72-E/MS
MCP6V72T-E/MS
MCP6V82-E/MS
MCP6V82T-E/MS
MCP6V92-E/MS
MCP6V92T-E/MS
MCP9801-M/MS
MCP9801-M/MSRC2
MCP9801T-M/MS
MCP9801T-M/MSRC2
MCP9803-M/MS
MCP9803-M/MSRC2
MCP9803T-M/MS
MCP9803T-M/MSRC2
MCP9804-E/MS
MCP9804-E/MSBBB
MCP9804T-E/MS
MCP9804T-E/MSBBB
MCP9808-E/MS
MCP9808T-E/MS
PIC12F508-E/MS
PIC12F508-I/MS
PIC12F508T-E/MS
PIC12F508T-I/MS
PIC12F508T-I/MS054
PIC12F508T-I/MS064
PIC12F508T-I/MS076
PIC12F508T-I/MS077
PIC12F509-E/MS
PIC12F509-I/MS
PIC12F509T-E/MS
PIC12F509T-I/MS
PIC12F509T-I/MS029
PIC12F510-E/MS
PIC12F510-I/MS
PIC12F510-I/MS04
PIC12F510T-E/MS
PIC12F510T-I/MS



JAON-15OELO113 - CCB 2594 Final Notice: Qualification of CuPdAu bond wire in selected products of the 150K and 160K wafer technologies available in 8L MSOP package at MTAI assembly site.

Affected Catalog Part Numbers (CPN)

PCN_JAON-15OELO113
CATALOG_PART_NBR
PIC12F519-E/MS
PIC12F519-I/MS
PIC12F519T-I/MS
PIC12F609-E/MS
PIC12F609-I/MS
PIC12F609T-E/MS
PIC12F609T-I/MS
PIC12F615-E/MS
PIC12F615-H/MS
PIC12F615-I/MS
PIC12F615-I/MS02
PIC12F615T-E/MS
PIC12F615T-H/MS
PIC12F615T-I/MS
PIC12F615T-I/MS059
PIC12F615T-I/MS063
PIC12F615T-I/MS068
PIC12F615T-I/MS080
PIC12F617-E/MS
PIC12F617-I/MS
PIC12F617-I/MS04
PIC12F617T-E/MS
PIC12F617T-I/MS
PIC12F617T-I/MS046
PIC12F617T-I/MS056
PIC12F617T-I/MS04
PIC12HV609-E/MS
PIC12HV609-I/MS
PIC12HV609T-I/MS
PIC12HV615-E/MS
PIC12HV615-I/MS
PIC12HV615T-E/MS
PIC12HV615T-I/MS
TCN75AVUA
TCN75AVUA713